MLSL2016A

20V/8A Dual N-Channel MOSFET

Features

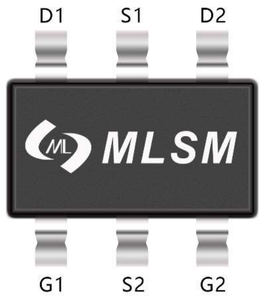
- Trench Power LV MOSFET technology
- High Power and current handing capability

Product Summary

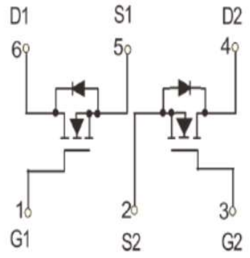
V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
20V	17mΩ@4.5V	8A
	23mΩ@2.5V	

Application

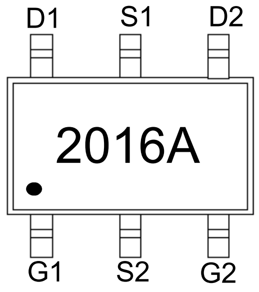
- PWM application
- Load switch



SOT-23-6L top view



Schematic diagram



2016A: Device code

Marking and pin assignment

Pb-Free RoHS Halogen-Free

Absolute Maximum Ratings (TA=25℃unless otherwise noted)				
Symbol	**Parameter**		**Rating**	**Unit**
Common Ratings (TC=25°C Unless Otherwise Noted)				
V_{DS}	Drain-Source Breakdown Voltage		20	V
V_{GS}	Gate-Source Voltage		±10	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C	8	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested	Tc=25°C	32	A
I_D	Continuous Drain Current	Tc=25°C	8	A
P_D	Maximum Power Dissipation	Tc=25°C	1.25	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient		325	°C/ W

Ordering Information (Example)						
Type	**Package**	**Marking**	**Minimum Package(pcs)**	**Inner Box Quantity(pcs)**	**Outer Carton Quantity(pcs)**	**Delivery Mode**
MLSL2016A	SOT-23-6L	2016A	3,000	45,000	180,000	7"reel

Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$BV_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V， I_D=250μA	20	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=20V， V_{GS}=0V	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±10V， V_{DS}=0V	--	--	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}， I_D=250μA	0.5	0.7	1.2	V
$R_{DS(on)}$	Drain-Source On-State Resistance	V_{GS}=4.5V， I_D=8.0A	--	12	17	mΩ
		V_{GS}=2.5V， I_D=7.5A	--	17	23	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C_{ISS}	Input Capacitance	V_{DS}=10V， V_{GS}=0V， f=1MHz	--	885	--	pF
C_{OSS}	Output Capacitance		--	135	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	120	--	pF
Switching Characteristics						
Q_g	Total Gate Charge	V_{DS}=10V， I_D=8A， V_{GS}=4.5V	--	11	--	nC
Q_{gs}	Gate Source Charge		--	1.75	--	nC
Q_{gd}	Gate Drain Charge		--	3	--	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=10V， R_L=1.5Ω， V_{GS}=4.5V， R_G=3Ω	--	7	--	nS
t_r	Turn-on Rise Time		--	45	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	30	--	nS
t_f	Turn-Off Fall Time		--	50	--	nS
Source- Drain Diode Characteristics						
V_{SD}	Forward on voltage	Tj=25℃， Is=8A	--	--	1.2	V

Typical Operating Characteristics

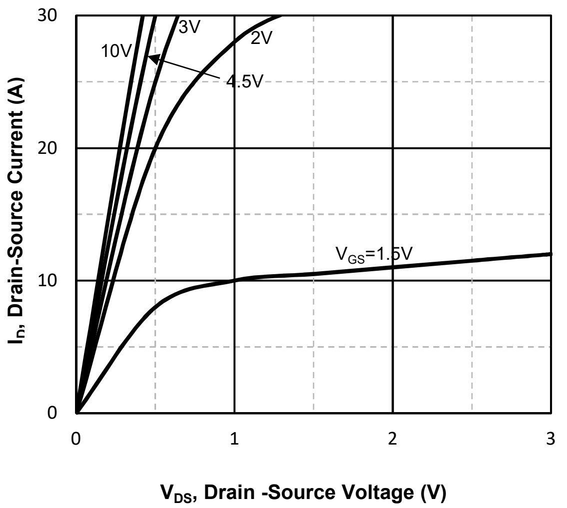


Fig1. Typical Output Characteristics

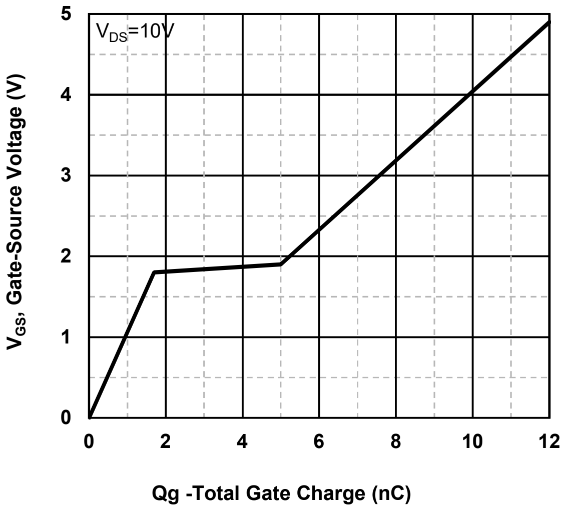


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

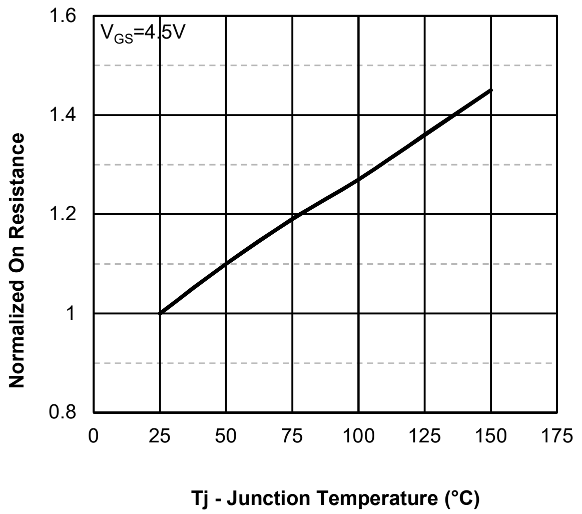


Fig3. Normalized On-Resistance Vs. Temperature

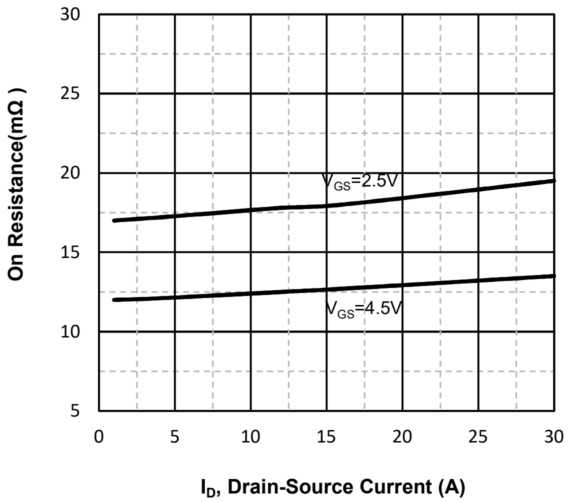


Fig4. On-Resistance Vs. Drain-Source Current

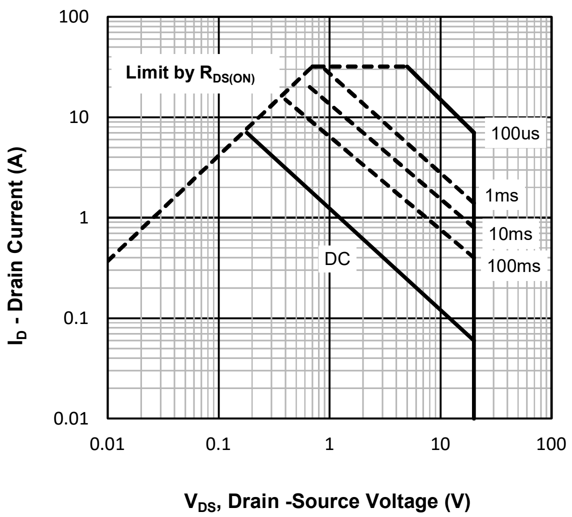


Fig5. Maximum Safe Operating Area

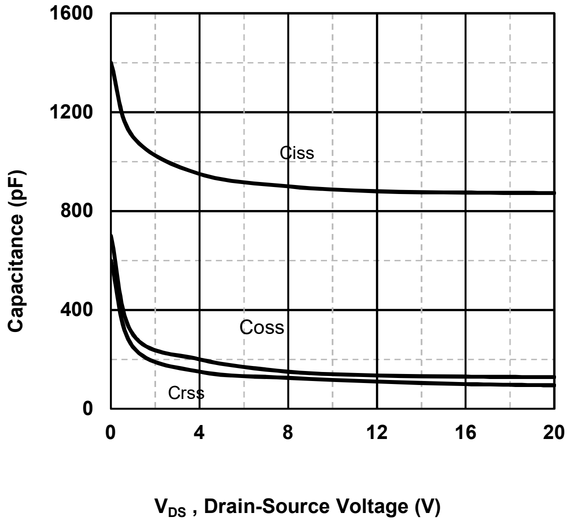
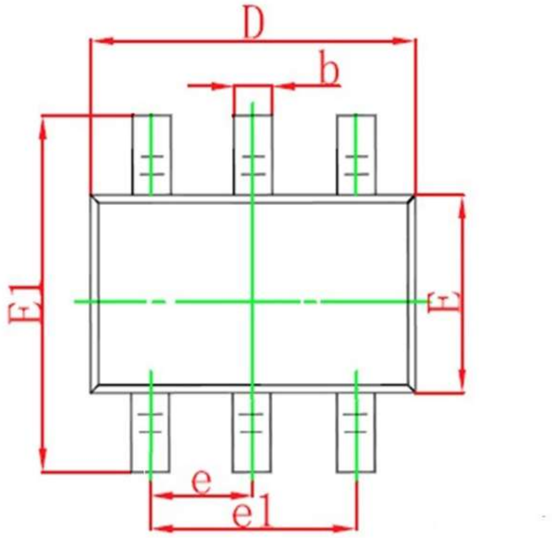
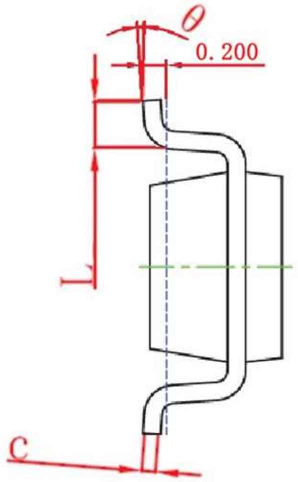
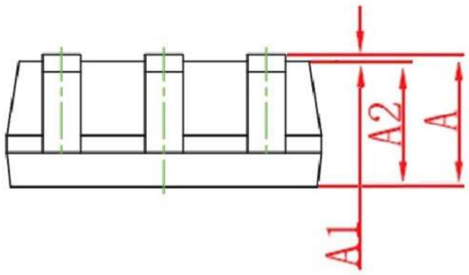


Fig6 Typical Capacitance Vs.Drain-Source Voltage

SOT-23-6L Package information







Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.000	1.200	0.039	0.047
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.600	3.000	0.102	0.118
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
K	0°	8°	0°	8°